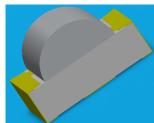


### **DATASHEET**

# Chip Infrared LED With spherical top view Lens LKIR30102C-A01(DY)



#### **Features**

- Small double-end package
- Low forward voltage
- Good spectral matching to Si photo detector
- Pb free
- The product itself will remain within RoHS compliant version
- Compliance with EU REACH
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

### **Descriptions**

- LKIR30102C-A01(DY) is an infrared emitting diode in miniature SMD package which is molded in a water clear epoxy with spherical top view lens.
- The device is spectrally matched with silicon photodiode and phototransistor

### **Applications**

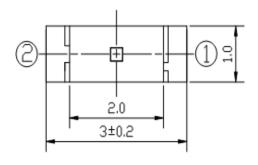
- PCB mounted infrared sensor
- Infrared emitting for miniature light barrier
- Floppy disk drive
- Optoelectronic switch
- Smoke detector

#### **Device Selection Guide**

Part Category	Chip Material	Lens Color	
IR	GaAlAs	Water Clear	



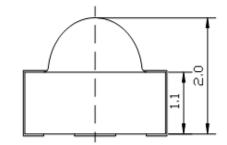
## **Package Dimensions**



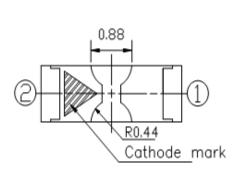


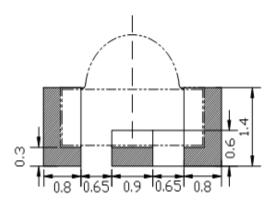
Polarity

- Anode
- ි Calthode



For reflow soldering(propose)





Notes: 1.All dimensions are in millimeters

- 2.Tolerances unless dimensions ± 0.1mm
- 3.Suggested pad dimension is just for reference only

Please modify the pad dimension based on individual need

## Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Units
Continuous Forward Current	lF	65	mA
Reverse Voltage	VR	5	V
Operating Temperature	Topr	-25 ~ +85	$^{\circ}$
Storage Temperature	T <sub>stg</sub>	-40 ~ +85	$^{\circ}$
Soldering Temperature*1	T <sub>sol</sub>	260	$^{\circ}$
Power Dissipation at (or below) 25°C Free Air Temperature	Pd	130	mW

**Notes:** \*1: Soldering time ≤ 5 seconds

## **Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	Condition	Min.	Тур.	Max.	Units
Radiant Intensity	le		0.56		1.25	mW/sr
Peak Wavelength	λр			940		nm
Spectral Bandwidth	Δλ	l⊧=20mA		45		nm
Forward Voltage	VF			1.2	1.5	V
View Angle	201/2			160		deg
Reverse Current	<b>I</b> R	VR=5V			10	μA

**Reverse Light Current Specifications for Bin Grading** 

			<u> </u>				
	Rank	Condition	Min	Max	Unit		
	F**		0.56	0.61			
	F*	l=20mA	0.61	0.75	mW/sr		
	F		0.75	1.25			

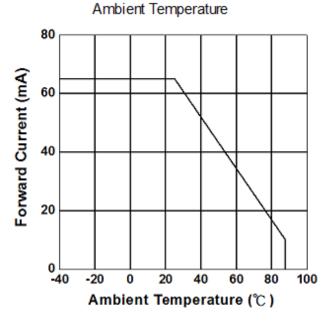
Notes: Tolerance of Luminous Intensity: ±11



## **Typical Electro-Optical Characteristics Curves**

Fig.1 Forward Current vs.

Fig.2 Spectral Distribution



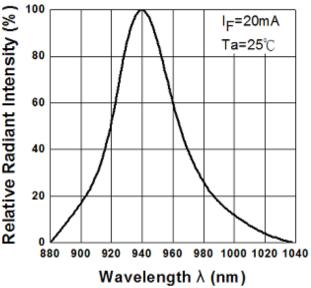
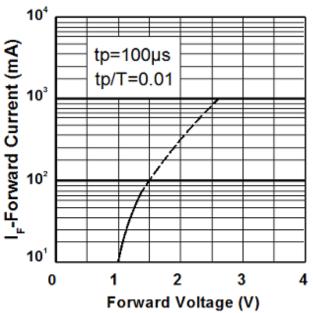
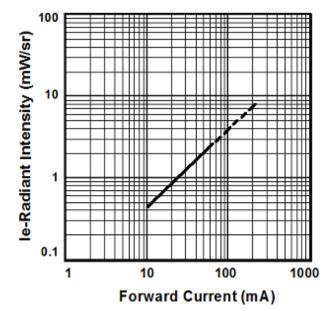


Fig.3 Forward Current vs.

Fig.4 Radiant Intensity vs.





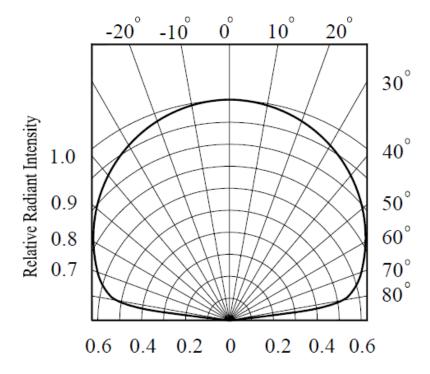




## **Typical Electro-Optical Characteristics Curves**

Fig.5 Relative Radiant Intensity vs.

Angular Displacement





#### **Precautions For Use**

#### 1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

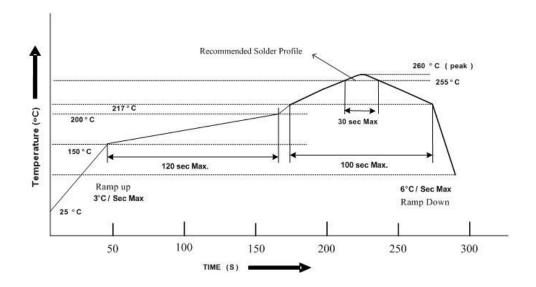
#### 2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 After opening the package: The LEDs should be kept at 30 ℃ or less and 60%RH or less.
- 2.3 The LEDs should be used within 168 hours (7days) after opening the package.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

  Baking treatment: 60±5°C for 24 hours.

#### 3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times
- 3.3 When soldering, do not put stress on the LEDs during heating
- 3.4 After soldering, do not warp the circuit board

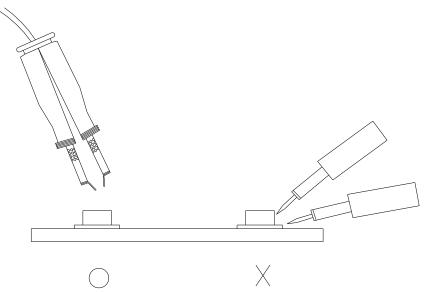


#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than  $350^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

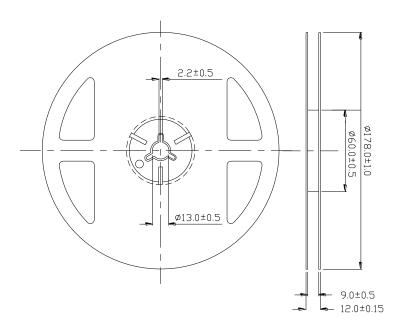
#### 5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



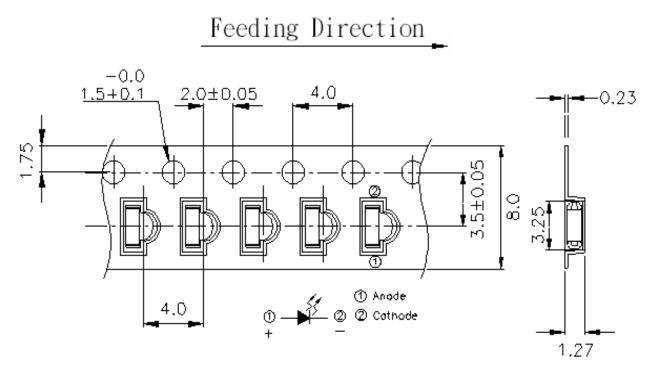


## **Package Dimensions**



Note: The tolerances unless mentioned are ±0.1mm, unit: mm

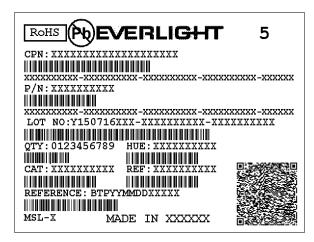
## **Carrier Taping Dimensions: (Quantity: 2000PCS/Reel)**



Note: The tolerances unless mentioned are ±0.1mm, unit: mm



### **Label Form Specification**



CPN: Customer's Production Number

P/N: Production Number

LOT No: Lot Number QTY: Packing Quantity HUE: Peak Wavelength

**CAT: Ranks** 

REF: Reference MSL-X: MSL Level

Made In: Manufacture place

#### **DISCLAIMER**

- 1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
- The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
- 3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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